Product Specification

3~5m 800G OSFP Finned Top to 4× 200G OSFP Flat Top InfiniBand NDR Active Copper Breakout Cable



Features

- Supports InfiniBand NDR to 4 × NDR200 breakout connectivity
- Supports 800G to 4 × 200G breakout
- 8 × 106.25 Gb/s PAM4 electrical lanes
- 2 × 106.25 Gb/s PAM4 lanes per 200G branch
- 53.125 GBd symbol rate per electrical lane
- Active linear signal-conditioning architecture
- 26 AWG and 30 AWG cable options
- Available in 3–5 m lengths
- Hot-pluggable OSFP Finned Top interfaces
- Single 3.3 V power supply
- Two-wire management interface with EEPROM identification
- Commercial operating temperature range: 0°C to +70°C

Compliance

- InfiniBand Architecture Specification (IBTA), NDR / NDR200
- OSFP MSA Rev. 5.2
- IEEE 802.3ck
- CMIS-compliant management interface
- RoHS compliant

Applications

- InfiniBand NDR / NDR200
- AI/ML clusters
- High-Performance Computing (HPC)
- GPU computing networks
- Cloud data centers
- NDR breakout links

Description

The O800-4O-NDR-AC is a high-performance Active Copper Cable (ACC) breakout assembly designed for InfiniBand NDR and NDR200 interconnections in AI, high-performance computing, and hyperscale data center environments. It connects one 800G OSFP Finned Top interface to four independent 200G OSFP Finned Top interfaces, enabling an 800G InfiniBand NDR interface to connect directly to four 200 Gb/s NDR200 ports.

The 800G host interface utilizes eight 106.25 Gb/s PAM4 electrical lanes, with two lanes allocated to each 200G OSFP branch. Each electrical lane operates at 53.125 GBd PAM4, providing an aggregate raw electrical line rate of 850 Gb/s at the host end and 212.5 Gb/s for each 200G branch.

Integrated active linear signal-conditioning electronics compensate for high-frequency copper-channel loss and extend the usable copper reach beyond conventional passive DAC solutions while maintaining low latency and low power consumption. The active copper architecture provides reliable medium-reach connectivity between compatible InfiniBand NDR and NDR200 switches, adapters, and systems.

Both the 800G host end and the four 200G branch ends use OSFP Finned Top interfaces with integrated thermal management. The 1-to-4 breakout architecture maps the eight host electrical lanes into four independent two-lane 200G interfaces. The same 100G-PAM4 electrical architecture also supports compatible Ethernet applications.

Available in 3 m, 4 m, and 5 m lengths, the O800-4O-NDR-AC uses active signal conditioning to support extended copper reach. A two-wire management interface provides EEPROM-based product identification, configuration information, and cable management functions. The cable is designed in accordance with InfiniBand NDR / NDR200 requirements, OSFP MSA Rev. 5.2, applicable IEEE 802.3ck electrical requirements, CMIS management requirements, and RoHS regulations.

Product performance Specifications

1、Absolute Maximum Ratings

Parameter	Symbol	Min	Typ.	Max	Unit
Storage Temperature	TS	-40		+85	°C
Supply Voltage	VCC	-0.3		+3.6	V

2、Recommended Operating Conditions

Parameter	Symbol	Min	Typ.	Max	Unit
Operating Case Temperature	TC	0		+70	°C
Power Supply Voltage	VCC	3.135	3.3	3.465	V
Relative Humidity	RH	5		85	%

3、General Product Specifications

Parameter	Specification	Condition
Product Type	Active Copper Cable (ACC) Breakout Cable	
Connector Configuration	1 × 800G OSFP Finned Top to 4 × 200G OSFP Finned Top	1-to-4 breakout
Supported Network Protocol	InfiniBand NDR / NDR200 / Ethernet	
InfiniBand Head-End Interface	NDR	
Branch Interface	NDR200	4 × 200 Gb/s
Aggregate Data Rate	800 Gb/s	4 × 200 Gb/s
Raw Electrical Line Rate	850 Gb/s	8 × 106.25 Gb/s
Raw Electrical Line Rate per Branch	212.5 Gb/s	2 × 106.25 Gb/s
Electrical Signaling	PAM4	
Number of Host Data Lanes	8 Full-Duplex Lanes	
Number of Data Lanes per Branch	2 Full-Duplex Lanes	
Data Rate per Lane	106.25 Gb/s	
Symbol Rate per Lane	53.125 GBd	PAM4
Electrical Lane Configuration	8 Tx + 8 Rx at host end; 2 Tx + 2 Rx per 200G branch	
Host Electrical Interface	8-lane 100G-PAM4 electrical interface	
Branch Electrical Interface	2-lane 100G-PAM4 electrical interface	Each branch
Cable Length	3 m, 4 m, 5 m	
Cable Gauge	26 AWG, 30 AWG	
Cable Type	Active Shielded Twinaxial Copper	
Host Connector Thermal Design	Finned Top	
Branch Connector Thermal Design	Finned Top	
Hot Pluggable	Supported	
Active Signal Conditioning	Supported	
Management Interface	Two-wire serial interface	
Module Identification	EEPROM	

4、Power Supply and Management Interface

Parameter	Symbol	Min	Typ.	Max	Unit
Power Supply Voltage	VCC	3.135	3.3	3.465	V
Management Interface			Two-wire serial interface		

Module Identification			EEPROM		
Management Architecture			CMIS		

5、High-Speed Electrical Characteristics

Parameter	Symbol	Min	Typ.	Max	Unit	Condition
Differential Impedance	Zdiff	90	100	110	Ω	Differential
Symbol Rate per Lane	SRL		53.125		GBd	PAM4
Raw Electrical Line Rate per Lane	DRL		106.25		Gb/s	PAM4
Effective Data Rate per Lane			100		Gb/s	
Host Electrical Lanes			8			Per direction
Electrical Lanes per Branch			2			Per direction
Aggregate Data Rate			800		Gb/s	
Data Rate per Branch			200		Gb/s	
Aggregate Raw Electrical Line Rate			850		Gb/s	
Raw Electrical Line Rate per Branch			212.5		Gb/s	
Active Signal Conditioning			Supported			

6、Active Signal Conditioning and Lane Architecture

Parameter	Specification
InfiniBand Interface	NDR / NDR200
Breakout Architecture	1 × 800G to 4 × 200G
Host Electrical Interface	8-lane 100G-PAM4 electrical interface
Branch Electrical Interface	2-lane 100G-PAM4 electrical interface
Signaling Architecture	8 × 100G-class PAM4
PAM4 Symbol Rate	53.125 GBd
Host Transmit Lanes	8 differential lanes
Host Receive Lanes	8 differential lanes
Branch Transmit Lanes	2 differential lanes per branch
Branch Receive Lanes	2 differential lanes per branch

Total Differential Signal Pairs	16
Raw Electrical Rate per Lane	106.25 Gb/s
Host Raw Electrical Line Rate	850 Gb/s
Raw Electrical Line Rate per Branch	212.5 Gb/s
Active Equalization	Supported
Signal Loss Compensation	Supported
Lane Mapping	8 lanes to 4 × 2 lanes

7、Cable Construction

Parameter	Specification
Cable Architecture	16 differential signal pairs total (8 Tx + 8 Rx)
Breakout Architecture	4 branch groups, each with 2 Tx + 2 Rx differential pairs
Cable Type	Shielded Active Twinaxial Copper
Conductor Gauge	26 AWG, 30 AWG
Differential Impedance	100 Ω nominal
High-Speed Signaling	106.25 Gb/s PAM4 per lane
Signal Conditioning	Integrated active linear equalization electronics
Cable Management	EEPROM-based identification and configuration
Host Connector	OSFP Finned Top
Branch Connectors	4 × OSFP Finned Top

8、Cable Configuration by Length

Cable Length	Recommended Wire Gauge	Host Connector	Branch Connectors
3 m	30 AWG	OSFP Finned Top	4 × OSFP Flat Top
4 m	30 AWG	OSFP Finned Top	4 × OSFP Flat Top
5 m	26 AWG	OSFP Finned Top	4 × OSFP Flat Top

9、Mechanical Interface

Parameter	Specification
Host Connector Form Factor	OSFP
Host Connector Top Type	Finned Top

Branch Connector Form Factor	OSFP
Branch Connector Top Type	Flat Top
Number of Branch Connectors	4
Host High-Speed Lanes	8 per direction
Branch High-Speed Lanes	2 per direction per branch
Total Differential Signal Pairs	16
Latching Mechanism	Pull-to-release

10、Environmental and Regulatory Characteristics

Parameter	Specification
Operating Temperature	0°C to +70°C
Storage Temperature	-40°C to +85°C
Operating Relative Humidity	5% to 85%
RoHS	Compliant

Pin-out Definition

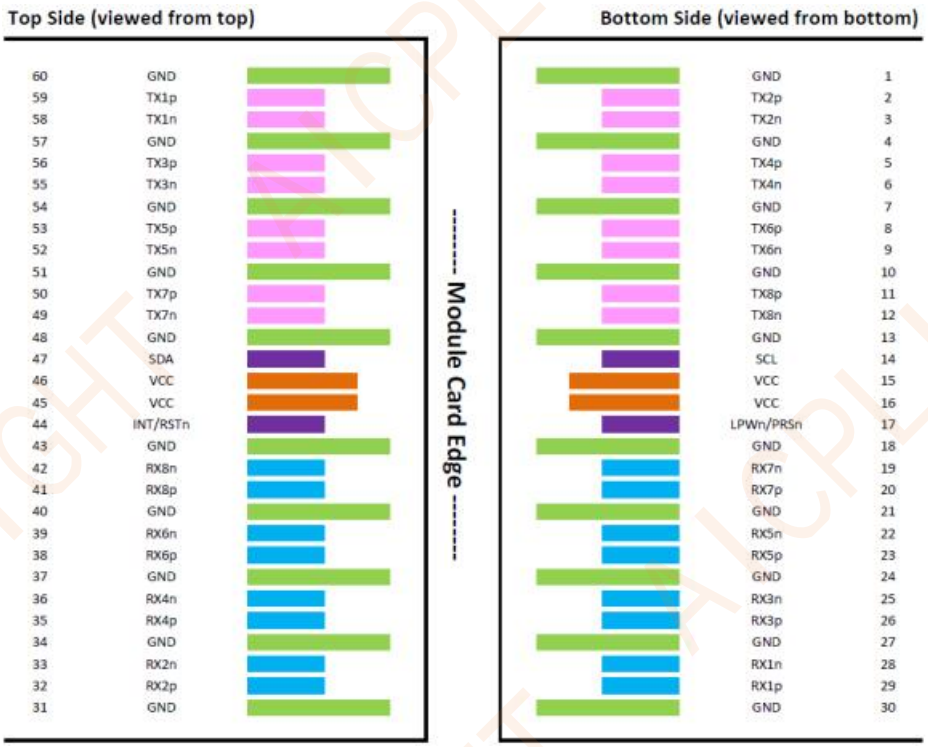


Figure4:Pin view

Pin Function Definitions

Pin	Logic	Symbol	Description	Note
1		GND	Ground	
2	CML-I	TX2p	Transmitter Data Non-Inverted	
3	CML-I	TX2n	Transmitter Data Inverted	
4		GND	Ground	
5	CML-I	TX4p	Transmitter Data Non-Inverted	
6	CML-I	TX4n	Transmitter Data Inverted	
7		GND	Ground	
8	CML-I	TX6p	Transmitter Data Non-Inverted	
9	CML-I	TX6n	Transmitter Data Inverted	
10		GND	Ground	
11	CML-I	TX8p	Transmitter Data Non-Inverted	
12	CML-I	TX8n	Transmitter Data Inverted	
13		GND	Ground	
14	LVCMOS-I/O	SCL	2-wire Serial interface clock	1
15		VCC	+3.3V Power	
16		VCC	+3.3V Power	
17	Multi-Level	LPWn/PRSn	Low-Power Mode / Module Present	2
18		GND	Ground	
19	CML-O	RX7n	Receiver Data Inverted	
20	CML-O	RX7p	Receiver Data Non-Inverted	
21		GND	Ground	
22	CML-O	RX5n	Receiver Data Inverted	
23	CML-O	RX5p	Receiver Data Non-Inverted	
24		GND	Ground	
25	CML-O	RX3n	Receiver Data Inverted	
26	CML-O	RX3p	Receiver Data Non-Inverted	
27		GND	Ground	
28	CML-O	RX1n	Receiver Data Inverted	
29	CML-O	RX1p	Receiver Data Non-Inverted	
30		GND	Ground	
31		GND	Ground	
32	CML-O	RX2p	Receiver Data Non-Inverted	
33	CML-O	RX2n	Receiver Data Inverted	
34		GND	Ground	
35	CML-O	RX4p	Receiver Data Non-Inverted	
36	CML-O	RX4n	Receiver Data Inverted	
37		GND	Ground	
38	CML-O	RX6p	Receiver Data Non-Inverted	

39	CML-O	RX6n	Receiver Data Inverted	
40		GND	Ground	
41	CML-O	RX8p	Receiver Data Non-Inverted	
42	CML-O	RX8n	Receiver Data Inverted	
43		GND	Ground	
44	Multi-Level	INT/RSTn	Module Interrupt / Module Reset	2
45		VCC	+3.3V Power	
46		VCC	+3.3V Power	
47	LVCMOS-I/O	SDA	2-wire Serial interface data	1
48		GND	Ground	
49	CML-I	TX7n	Transmitter Data Inverted	
50	CML-I	TX7p	Transmitter Data Non-Inverted	
51		GND	Ground	
52	CML-I	TX5n	Transmitter Data Inverted	
53	CML-I	TX5p	Transmitter Data Non-Inverted	
54		GND	Ground	
55	CML-I	TX3n	Transmitter Data Inverted	
56	CML-I	TX3p	Transmitter Data Non-Inverted	
57		GND	Ground	
58	CML-I	TX1n	Transmitter Data Inverted	
59	CML-I	TX1p	Transmitter Data Non-Inverted	
60		GND	Ground	

Note1: Open-Drain with pull up resistor on Host.

Note2: See pin description for required circuit.

Monitoring Specification

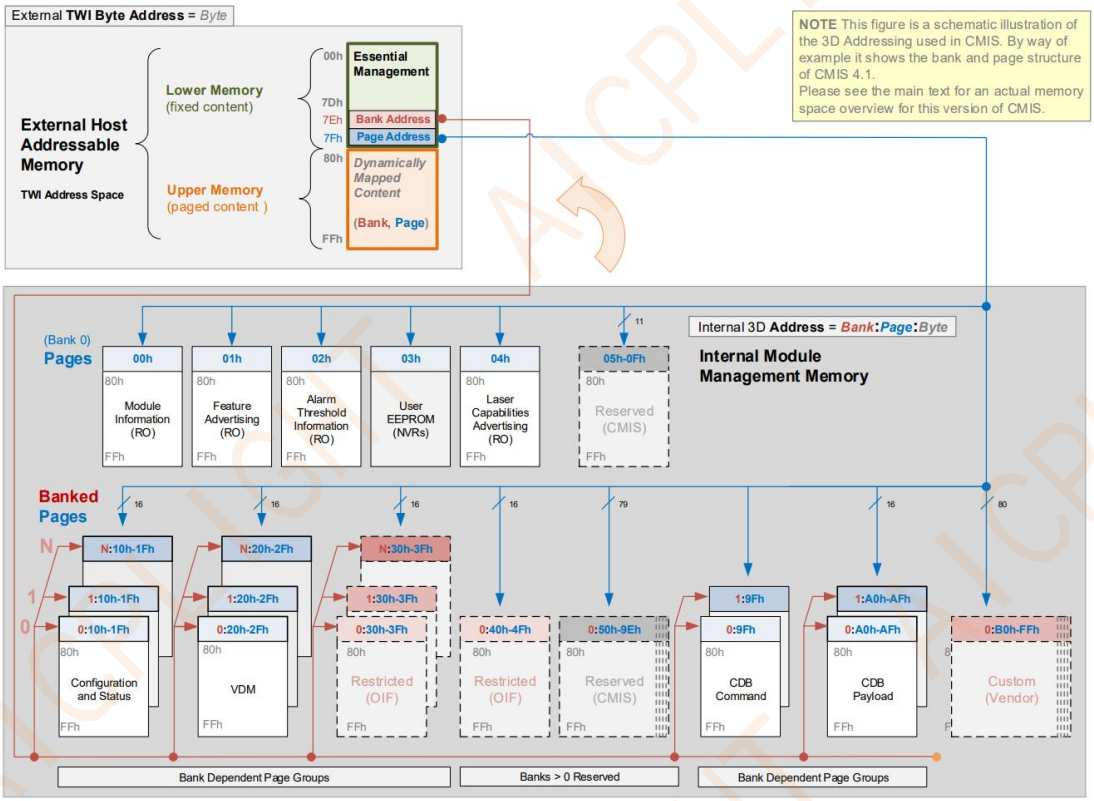
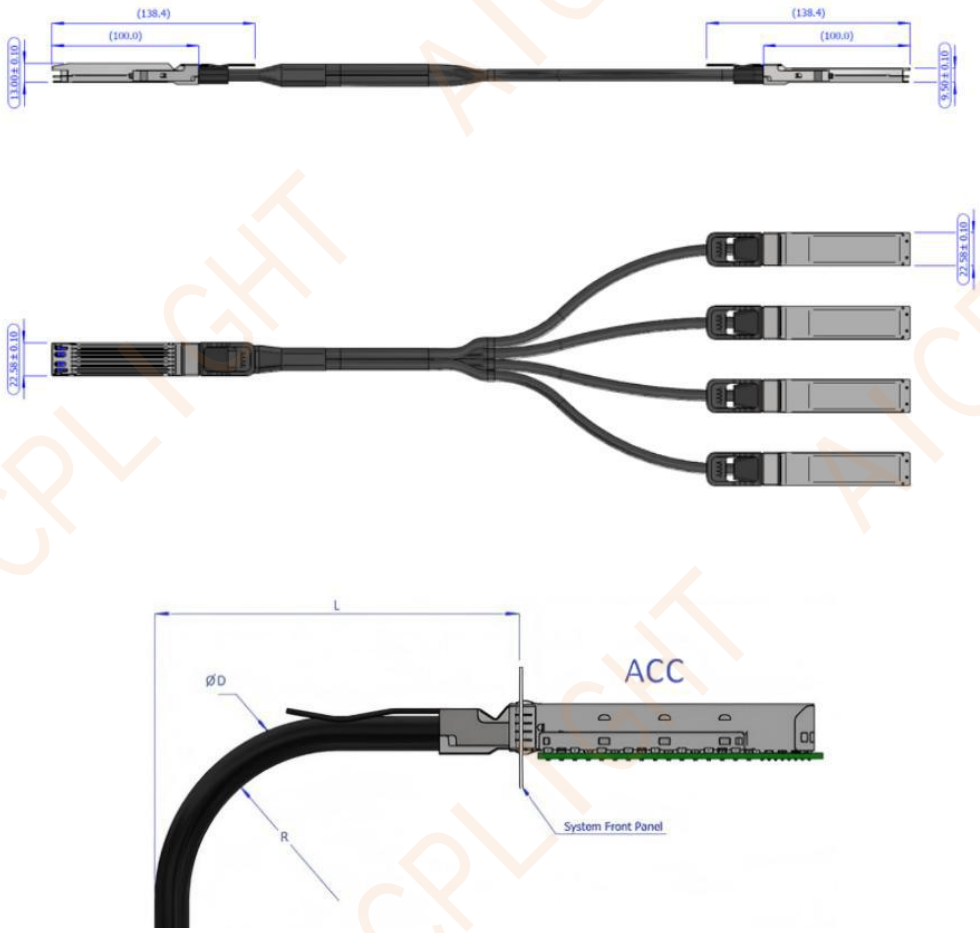


Figure5: Memory map

Memory map Table

Byte	Unit	Name	Description
		Lower Page 00h	
0-2	3	Management Characteristics	Basic Information about how this module is managed
3	1	Global Status Information	Current state of Module, Interrupt signal status
4-7	4	Flag Summary	Summary of Flags set on specific Pages (and Banks)
8-13	6	Module-Level Flags	Flags that are not lane or Data Path specific
14-25	12	Module-Level Monitors	Monitors that are not lane or Data Path specific
26-30	5	Module-Level Controls	Controls applicable to the module as a whole
31-36	6	Module-Level Masks	Mask bits for the Module-Level Flags
37-38	2	CDB Command Status	Status of current CDB command
39-40	2	Module Active Firmware Version	Module Active Firmware Version number
41	1	Fault Information	Fault cause for entering ModuleFault state
42-63	22		Reserved
64-84	21		Custom
85-117	33	Supported Applications Advertising	Applications supported by module Data Path(s)
118-125	8	Password Facilities	Password Entry and Change (mechanism only)
126-127	2	Page Mapping	Page mapping into host addressable Upper Memory
		Upper Page 00h	
128	1	SFF8024IdentifierCopy	Copy of Byte 00h:0
129-144	16	VendorName	Vendor name (ASCII)
145-147	3	Vendor OUI	Vendor IEEE company ID
148-163	16	Vendor PN	Part number provided by vendor (ASCII)
164-165	2	Vendor Rev	Revision level for part number provided by vendor (ASCII)
166-181	16	Vendor SN	Vendor Serial Number (ASCII)
182-189	8	DateCode	Manufacturing Date Code (ASCII)
190-199	10	CLEICode	Common Language Equipment Identification Code (ASCII)
200-201	2	ModulePowerCharacteristics	Module power characteristics
202	1	CableAssemblyLinkLength	Cable length (for cable assembly modules only)
203	1	ConnectorType	Connector type of the media interface
204-209	6	Copper Cable Attenuation	Attenuation characteristics (passive copper cables only)
210	1	MediaLaneInformation	Supported near end media lanes (all modules)
211	1	Cable Assembly Information	Far end modules information (cable assemblies only)
212	1	MediaInterfaceTechnology	Information on media side device or cable technology
213-220	8		Reserved
221	1		Custom
222	1	PageChecksum	Page Checksum over bytes 128-221
223-255	33		Custom

Mechanical Dimension



Note:

- All dimensions are in mm.
- Unless otherwise specified, dimensional tolerance is ±0.1 mm.
- Latch color: Black.
- Cable length tolerance: ±25 mm for L < 2 m and ±50 mm for L ≥ 2 m.

Handling and Safety Precautions:

- ESD Precautions: Follow standard ESD handling procedures when handling or installing the cable assembly, particularly at the connector ends.
- Bend Radius: Do not bend the cable below the specified minimum bend radius. Avoid sharp bends or repeated bending near the connector strain-relief area.
- Cable Handling: Avoid excessive pulling, twisting, crushing, kinking, or other mechanical stress that may damage the cable or affect signal integrity.
- Installation and Removal: Use the pull tab or release mechanism when inserting or removing the cable assembly. Do not pull directly on the cable.
- Connector Protection: Keep the electrical connector contacts clean and protected from dust, moisture, and contamination when not installed.
- Cable Assembly Protection: Do not disassemble, modify, splice, or attempt to repair the cable assembly or connector housing. Replace the cable if physical damage is observed.

Ordering Information

PN	Description
O800-4O-NDR-AC3	800G OSFP Finned Top to 4× 200G OSFP Flat Top InfiniBand NDR Active Copper Breakout Cable,3m
O800-4O-NDR-AC4	800G OSFP Finned Top to 4× 200G OSFP Flat Top InfiniBand NDR Active Copper Breakout Cable,4m
O800-4O-NDR-AC5	800G OSFP Finned Top to 4× 200G OSFP Flat Top InfiniBand NDR Active Copper Breakout Cable,5m